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# 1 Electrical ratings

Symbol	Parameter	Value	Unit		
V <sub>GS</sub>	Gate- source voltage	±25	V		
	Drain current (continuous) at T <sub>C</sub> = 25 °C	84	Α		
Ι <sub>D</sub>	Drain current (continuous) at T <sub>C</sub> = 100 °C	50.5	A		
I <sub>DM</sub> <sup>(1)</sup>	Drain current (pulsed) 336				
P <sub>TOT</sub>	Total dissipation at T <sub>C</sub> = 25 °C	450	W		
I <sub>AR</sub>	Max. current during repetitive or single pulse avalanche (pulse width limited by T <sub>jmax</sub> )	15	А		
E <sub>AS</sub>	Single pulse avalanche energy (starting $T_j = 25 \ ^\circ C$ , $I_D = I_{AR}$ , $V_{DD} = 50 \ V$ )2000		mJ		
dv/dt <sup>(2)</sup>	<sup>2)</sup> Peak diode recovery voltage slope 15		V/ns		
T <sub>stg</sub>	Storage temperature	- 55 to 150			
Тj	Max. operating junction temperature	150			

#### Table 2. Absolute maximum ratings

1. Pulse width limited by safe operating area.

2. I\_{SD}  $\leq$  84 A, di/dt = 400 A/µs, peak V<sub>DS</sub> < V<sub>(BR)DSS</sub>, V<sub>DD</sub> = 400 V.

#### Table 3. Thermal data

Symbol	Parameter Value			
R <sub>thj-case</sub>	Thermal resistance junction-case max.	0.28	°C/W	
R <sub>thj-amb</sub>	Thermal resistance junction-ambient max.	50	°C/W	



#### 2 **Electrical characteristics**

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V <sub>(BR)DSS</sub>	Drain-source breakdown voltage	$I_{D} = 1 \text{ mA}, V_{GS} = 0 \text{ V}$	650			V
I <sub>DSS</sub>	Zero gate voltage	$V_{GS} = 0 V, V_{DS} = 650 V$			1	
	drain current	$V_{GS} = 0 V, V_{DS} = 650 V,$ $T_{C} = 125 °C$			100	μA
I <sub>GSS</sub>	Gate-body leakage current	$V_{DS} = 0 \text{ V}, \text{ V}_{GS} = \pm 25 \text{ V}$			± 100	nA
V <sub>GS(th)</sub>	Gate threshold voltage	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$	3	4	5	V
R <sub>DS(on)</sub>	Static drain-source on- resistance	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 42 A		0.024	0.029	Ω

Table 4 Statio

Table 5. Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C <sub>iss</sub>	Input capacitance		-	8825	-	
C <sub>oss</sub>	Output capacitance	V <sub>DS</sub> = 100 V, f = 1 MHz,	-	223	-	pF
C <sub>rss</sub>	Reverse transfer capacitance	$V_{GS} = 0 V$	-	11	-	
C <sub>o(tr)</sub> <sup>(1)</sup>	Equivalent capacitance time related	- V <sub>GS</sub> = 0 V, V <sub>DS</sub> = 0 to 520 V	-	778	-	рF
C <sub>o(er)</sub> <sup>(2)</sup>	Equivalent capacitance energy related	$v_{GS} = 0.0, v_{DS} = 0.00320$ v	-	202	-	рг
R <sub>G</sub>	Intrinsic gate resistance	f = 1 MHz open drain	-	1.79	-	Ω
Qg	Total gate charge	V <sub>DD</sub> = 520 V, I <sub>D</sub> = 42 A,	-	204	-	
Q <sub>gs</sub>	Gate-source charge	V <sub>GS</sub> = 10 V	-	51	-	nC
Q <sub>gd</sub>	Gate-drain charge	(see Figure 16)	-	84	-	

1.  $C_{o(tr)}$  is a constant capacitance value that gives the same charging time as  $C_{oss}$  while  $V_{DS}$  is rising from 0 to 80%  $V_{DSS}$ .

C<sub>o(er)</sub> is a constant capacitance value that gives the same stored energy as C<sub>oss</sub> while V<sub>DS</sub> is rising from 0 to 80% V<sub>DSS</sub>.



_							
	Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
	t <sub>d(V)</sub>	Voltage delay time		-	150	-	
	t <sub>r(V)</sub>	Voltage rise time	$V_{DD} = 400 \text{ V}, \text{ I}_{D} = 56 \text{ A}$		19	-	
	t <sub>f(i)</sub>	Current fall time	$R_G = 7.2 \Omega V_{GS} = 10 V$ (see <i>Figure 17</i> and 20)	-	24	-	ns
	t <sub>c(off)</sub>	Crossing time		-	45	-	

Table 6. Switching times

Table 7. Source-drain diode

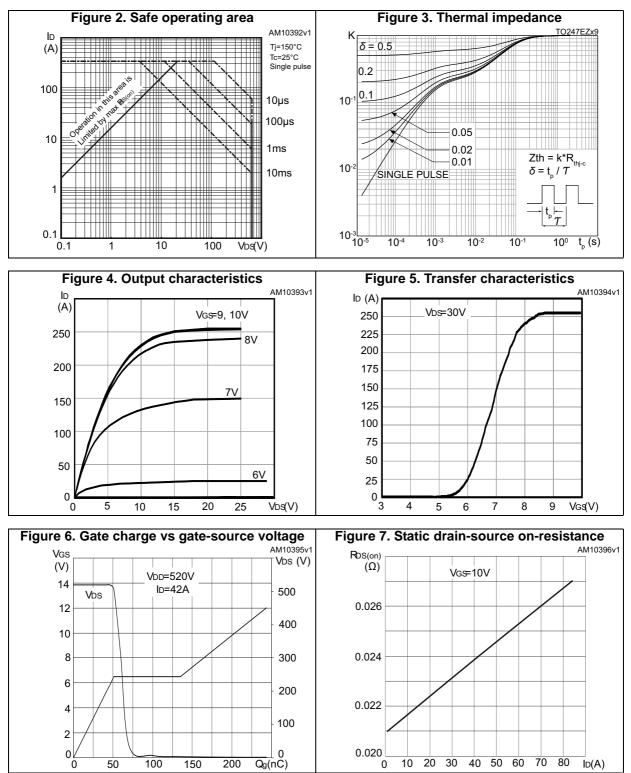
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I <sub>SD</sub>	Source-drain current		-		84	А
I <sub>SDM</sub> <sup>(1)</sup>	Source-drain current (pulsed)		-		336	А
V <sub>SD</sub> <sup>(2)</sup>	Forward on voltage	I <sub>SD</sub> = 84 A, V <sub>GS</sub> = 0	-		1.5	V
t <sub>rr</sub>	Reverse recovery time	I <sub>SD</sub> = 84 A,	-	544		ns
Q <sub>rr</sub>	Reverse recovery charge	di/dt = 100 A/µs	-	14		μC
I <sub>RRM</sub>	Reverse recovery current	$V_{DD} = 100 V (see Figure 17)$	-	50		А
t <sub>rr</sub>	Reverse recovery time	I <sub>SD</sub> = 84 A,	-	660		ns
Q <sub>rr</sub>	Reverse recovery charge	di/dt = 100 A/µs V <sub>DD</sub> = 100 V, T <sub>i</sub> = 150 °C	-	20		μC
I <sub>RRM</sub>	Reverse recovery current	(see <i>Figure 17</i> )	-	60		А

1. Pulse width limited by safe operating area.

2. Pulsed: pulse duration =  $300 \ \mu s$ , duty cycle 1.5%.

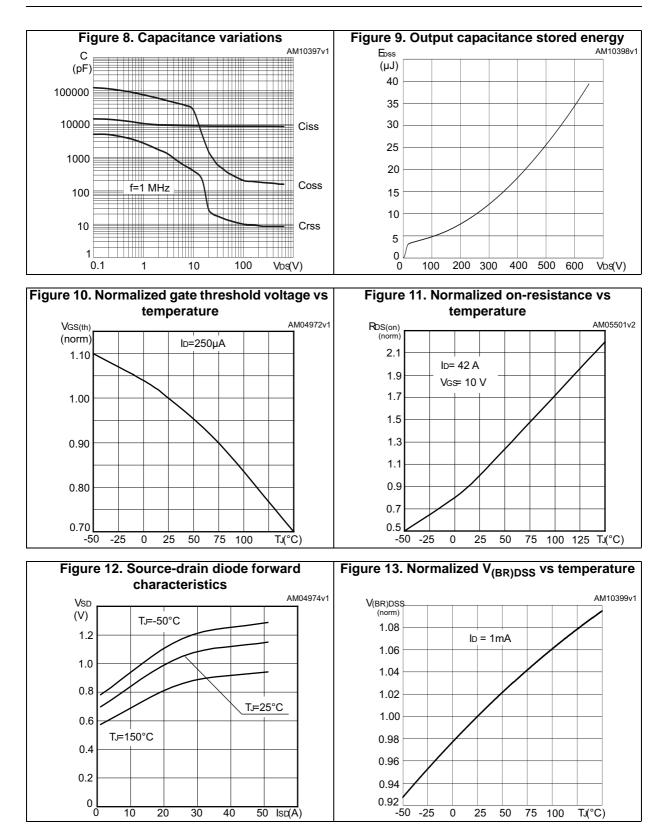


### 2.1 Electrical characteristics (curves)



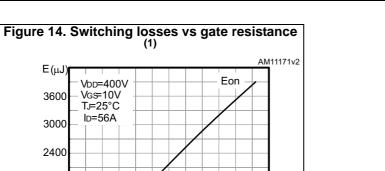
6/13





57

E(μJ)



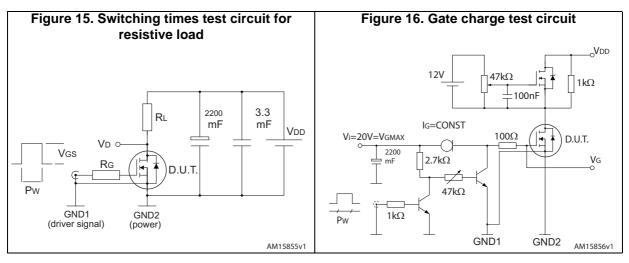
Eoff RG(Ω)

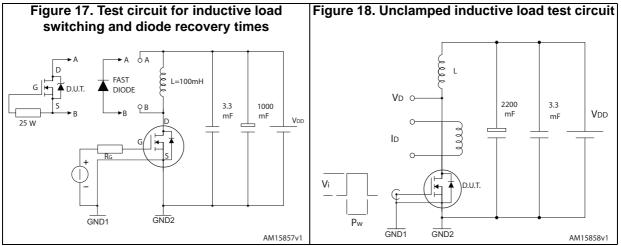
1. Eon including reverse recovery of a SiC diode.

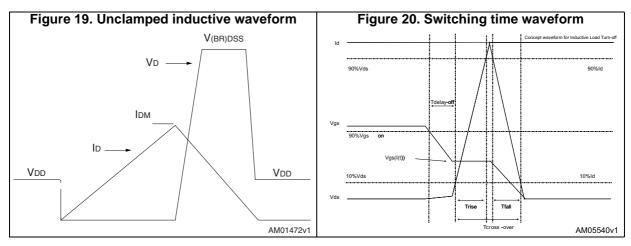




## 3 Test circuits









### 4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK<sup>®</sup> packages, depending on their level of environmental compliance. ECOPACK<sup>®</sup> specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK<sup>®</sup> is an ST trademark.

#### 4.1 TO247-4 package information

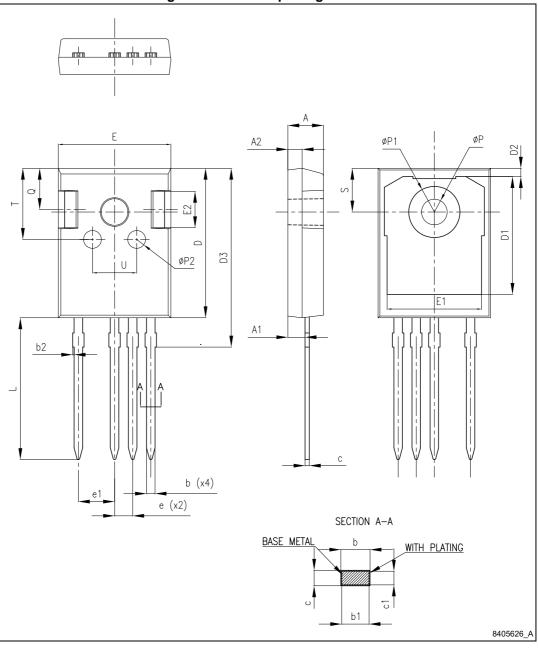


Figure 21. TO247-4 package outline





Table 8. TO247-4 package mechanical data					
Dim.		mm			
Dini.	Min.	Тур.	Max.		
А	4.90	5.00	5.10		
A1	2.31	2.41	2.51		
A2	1.90	2.00	2.10		
b	1.16		1.29		
b1	1.15	1.20	1.25		
b2	0		0.20		
С	0.59		0.66		
c1	0.58	0.60	0.62		
D	20.90	21.00	21.10		
D1	16.25	16.55	16.85		
D2	1.05	1.20	1.35		
D3	24.97	25.12	25.27		
E	15.70	15.80	15.90		
E1	13.10	13.30	13.50		
E2	4.90	5.00	5.10		
E3	2.40	2.50	2.60		
е	2.44	2.54	2.64		
e1	4.98	5.08	5.18		
L	19.80	19.92	20.10		
Р	3.50	3.60	3.70		
P1			7.40		
P2	2.40	2.50	2.60		
Q	5.60		6.00		
S		6.15			
Т	9.80		10.20		
U	6.00		6.40		

Table 8. TO247-4 package mechanical data



# 5 Revision history

revision history
1

Date	Revision	Changes
21-Oct-2015	1	First release.



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